

Ultra Small Voltage Detector with High Precision Delay Circuit and Manual Reset Function

■ GENERAL DESCRIPTION

XC6127 series is ultra small highly accurate voltage detector with delay circuit built-in.

The device includes a highly accurate reference voltage source, manufactured using CMOS process technology and laser trimming technologies, it maintains high accuracy, low power consumption, and accurate releases delay time over the full operation temperature range.

The release delay time periods are internally set in a range from 50ms to 800ms.

Moreover, with the manual reset function, reset can be asserted at any time.

The device is available in both CMOS and N-channel open drain output configurations. Also detect logic is available in both RESETB (Active Low) and RESET (Active High).

Ultra small package USPN-4 is ideally suited for small design of portable devices and high densely mounting applications. The conventional packages SSOT-24, SOT-25 is also available for upper compatible replacements.

■ APPLICATIONS

- Microprocessor logic reset circuitry
- System battery life and charge voltage monitors
- Memory battery back-up circuits
- Power-on reset circuits
- Power failure Detection
- Delay circuit

■ FEATURES

| | |
|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| High Accuracy | : $\pm 0.8\%$ (25°C) |
| Temperature Characteristics | : $\pm 50\text{ppm}/^\circ\text{C}$ |
| Low Power Consumption | : $0.6\ \mu\text{A}$ TYP. (Detect: $V_{DF}=1.8\text{V}$, $V_{IN}=1.62\text{V}$) $0.7\ \mu\text{A}$ TYP. (Release: $V_{DF}=1.8\text{V}$, $V_{IN}=1.98\text{V}$) |
| Operating Voltage Range | : $0.7\text{V}\sim 6.0\text{V}$ |
| Detect Voltage Range | : $1.5\text{V}\sim 5.5\text{V}$ (0.1V increments) |
| Manual Reset Input | : MRB Pin (Built-in Pull-up resistance) |
| Output Configuration | : N-channel open drain or CMOS |
| Output Logic | : RESETB (Active Low) RESET (Active High) |
| Release Delay Time | : 50ms/100ms/200ms/400ms/800ms $\pm 15\%$ |
| Operating Ambient Temperature | : $-40^\circ\text{C} \sim +85^\circ\text{C}$ |
| Packages | : USPN-4, SSOT-24, SOT-25 |
| Environmentally Friendly | : EU RoHS Compliant, Pb Free |

■ TYPICAL APPLICATION CIRCUIT



■ TYPICAL PERFORMANCE CHARACTERISTICS



PIN CONFIGURATION



PIN ASSIGNMENT

| PIN NUMBER | | | PIN NAME | FUNCTIONS |
|------------|---------|--------|-----------------|---------------------------------------------|
| USPN-4 | SSOT-24 | SOT-25 | | |
| 1 | 4 | 4 | RESETB | Signal Output (Active Low) ^(*1) |
| 1 | 4 | 4 | RESET | Signal Output (Active High) ^(*2) |
| 2 | 3 | 1 | MRB | Manual Reset Input |
| 3 | 2 | 2 | V _{SS} | Ground |
| 4 | 1 | 5 | V _{IN} | Power Input |

(*1) Type A~E (Refer to the ④ in Ordering Information table)

(*2) Type F~K (Refer to the ④ in Ordering Information table)

FUNCTION CHART

| PIN NAME | SIGNAL | STATUS |
|----------|--------|------------------|
| MRB | L | Forced Reset |
| | H | Normal Operation |
| | OPEN | Normal Operation |

■ PRODUCT CLASSIFICATION

● Ordering Information

XC6127①②③④⑤⑥-⑦^(*)

| DESIGNATOR | ITEM | SYMBOL | DESCRIPTION |
|---------------------|-----------------------|--------|----------------------------------------------|
| ① | Output Configuration | C | CMOS output |
| | | N | N-ch open drain output |
| ②③ | Detect Voltage | 15~55 | e.g. 2.7V → ②=2, ③=7 |
| ④ | Type | A | Reset Active Low, Release Delay Time: 50ms |
| | | B | Reset Active Low, Release Delay Time: 100ms |
| | | C | Reset Active Low, Release Delay Time: 200ms |
| | | D | Reset Active Low, Release Delay Time: 400ms |
| | | E | Reset Active Low, Release Delay Time: 800ms |
| | | F | Reset Active High, Release Delay Time: 50ms |
| | | G | Reset Active High, Release Delay Time: 100ms |
| | | H | Reset Active High, Release Delay Time: 200ms |
| | | J | Reset Active High, Release Delay Time: 400ms |
| | | K | Reset Active High, Release Delay Time: 800ms |
| ⑤⑥-⑦ ^(*) | Packages (Order Unit) | 7R-G | USPN-4 (5,000/Reel) |
| | | MR-G | SOT-25 (3,000/Reel) |
| | | NR-G | SSOT-24 (3,000/Reel) |

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ BLOCK DIAGRAMS

1) XC6127 Series, Type CxxA/CxxB/CxxC/CxxD/CxxE (CMOS Output, Output Logic: Active Low)



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

2) XC6127 Series, Type NxxA/NxxB/NxxC/NxxD/NxxE (N-ch Open Drain Output, Output Logic: Active Low)



* Diodes inside the circuits are ESD protection diodes

■ BLOCK DIAGRAMS (Continued)

3) XC6127 Series, Type CxxF/CxxG/CxxH/CxxJ/CxxK (CMOS Output, Output Logic: Active High)



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

4) XC6127 Series, Type NxxF/NxxG/NxxH/NxxJ/NxxK (N-ch Open Drain Output, Output Logic: Active High)



* Diodes inside the circuits are ESD protection diodes.

■ ABSOLUTE MAXIMUM RATINGS

Ta=25°C

| PARAMETER | | SYMBOL | RATINGS | UNITS |
|-------------------------------|--------------|------------------|------------------------------------------------------------------|-------|
| Input Voltage | | V _{IN} | V _{SS} -0.3~V _{SS} +6.5 | V |
| MRB Input Voltage | | V _{MRB} | V _{SS} ~V _{SS} +6.5 | V |
| Output Current | | (*1) | 20 | mA |
| Output Voltage | XC6127C (*2) | (*4) | V _{SS} -0.3~V _{IN} +0.3 ≤ V _{SS} +6.5 | V |
| | XC6127N (*3) | | V _{SS} -0.3~V _{SS} +6.5 | |
| Power Dissipation | USPN-4 | Pd | 100 | mW |
| | SOT-25 | | 250 | |
| | SSOT-24 | | 150 | |
| Operating Ambient Temperature | | Topr | -40~+85 | °C |
| Storage Temperature | | Tstg | -55~+125 | °C |

Note:

(*1) SYMBOL is different for each product.

I_{RBOUT}: Type XC6127CxxA/CxxB/CxxC/CxxD/CxxE, Type XC6127NxxA/NxxB/NxxC/NxxD/NxxE

I_{ROUT}: Type XC6127CxxF/CxxG/CxxH/CxxJ/CxxK, Type XC6127NxxF/NxxG/NxxH/NxxJ/NxxK

(*2) CMOS Output

(*3) N-ch Open Drain Output

(*4) SYMBOL is different for each product.

V_{RESETB}: Type XC6127CxxA/CxxB/CxxC/CxxD/CxxE, Type XC6127NxxA/NxxB/NxxC/NxxD/NxxE

V_{RESET}: Type XC6127CxxF/CxxG/CxxH/CxxJ/CxxK, Type XC6127NxxF/NxxG/NxxH/NxxJ/NxxK

ELECTRICAL CHARACTERISTICS

●XC6127CxxA/CxxB/CxxC/CxxD/CxxE, XC6127NxxA/NxxB/NxxC/NxxD/NxxE (Output Logic: Active Low)

Ta=25°C

| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS | CIRCUIT |
|-------------------------------------------|--------------------------------------------------------------|------------------------------------------------------------------------------------------|---------------------------------------------------------------------------|------------------------|---------------------------|--------|---------|
| Operating Voltage | V _{IN} | V _{DF(T)} ^{(*)1} =1.5~5.5V, MRB=OPEN ^{(*)2} | 0.7 ^{(*)3} | | 6.0 | V | - |
| Detect Voltage | V _{DFL} | V _{DF(T)} =1.5~5.5V, MRB=OPEN | V _{DF(T)} ×0.992 | V _{DF(T)} | V _{DF(T)} ×1.008 | V | ① |
| | | | E-1 ^{(*)4} | | | | |
| Hysteresis Width | V _{HYS} | | V _{DFL} ×0.02 | V _{DFL} ×0.05 | V _{DFL} ×0.08 | V | ① |
| Supply Current 1 | I _{SS1} | V _{IN} =V _{DFL} ×0.9, MRB=OPEN | - | 0.6 | 1.4 | μA | ② |
| | | V _{DF(T)} =1.5~1.8V | - | 0.7 | 1.6 | | |
| | | V _{DF(T)} =1.9~3.0V | - | 1.0 | 1.9 | | |
| Supply Current 2 | I _{SS2} | V _{IN} =V _{DFL} ×1.1 ^{(*)5} , MRB=OPEN | - | 0.7 | 1.6 | μA | ② |
| | | V _{DF(T)} =1.5~1.8V | - | 0.8 | 1.9 | | |
| | | V _{DF(T)} =1.9~3.0V | - | 1.1 | 2.35 | | |
| RESETB Output Current | I _{RBOUT1} | V _{IN} =0.7V, V _{RESETB} =0.5V(Nch), MRB=OPEN | 0.014 | 0.2 | - | mA | ③ |
| | | V _{IN} =1.0V, V _{RESETB} =0.5V(Nch), MRB=OPEN | 0.5 | 1.6 | - | | |
| | | V _{IN} =2.0V ^{(*)6} , V _{RESETB} =0.5V(Nch), MRB=OPEN | 4.4 | 7.0 | - | | |
| | | V _{IN} =3.0V ^{(*)7} , V _{RESETB} =0.5V(Nch), MRB=OPEN | 7.0 | 9.0 | - | | |
| | | V _{IN} =4.0V ^{(*)8} , V _{RESETB} =0.5V(Nch), MRB=OPEN | 8.5 | 11.0 | - | | |
| | I _{RBOUT2} ^{(*)10} | V _{IN} =6.0V, V _{RESETB} =5.5V(Pch), MRB=OPEN | - | -4.5 | -3.0 | mA | ③ |
| RESETB Leakage Current | CMOS Output(Pch) | I _{LEAK} | V _{IN} =V _{DFL} ×0.9, V _{RESETB} =0V, MRB=OPEN | - | -0.01 | μA | ③ |
| | Nch Open Drain Output | | V _{IN} =6.0V, V _{RESETB} =6.0V, MRB=OPEN | - | 0.01 | 0.15 | |
| Temperature Characteristics | ΔV _{DFL} / (ΔT _{OP} ·V _{DFL}) | -40°C ≤ T _{OP} ≤ 85°C | - | ±50 | - | ppm/°C | ① |
| Detect Delay Time ^{(*)11} | t _{DF} | V _{IN} =V _{DFL} ×1.1→V _{DFL} ×0.9 ^{(*)11} , MRB=OPEN | - | - | 100 | μs | ④ |
| Release Delay Time ^{(*)12} | t _{DR} | V _{IN} =V _{DFL} ×0.9→V _{DFL} ×1.1 ^{(*)12} , MRB=OPEN | E-2 ^{(*)13} | | | ms | ④ |
| MRB "Low" Level Voltage ^{(*)14} | V _{MRL} | V _{DFL} ×1.1 ≤ V _{IN} ≤ 6.0V | V _{SS} | - | 0.3 | V | ⑤ |
| MRB "High" Level Voltage ^{(*)14} | V _{MRH} | V _{DFL} ×1.1 ≤ V _{IN} ≤ 6.0V | 1.0 | - | 6.0 | V | ⑤ |
| MRB pull-up Resistance | R _{MRB} | | 0.4 | 0.8 | 3.0 | MΩ | ⑥ |
| Minimum MRB Pulse Width | T _{MRB} | V _{IN} =6.0V, Applied pulse to MRB pin, | 150 | - | - | ns | ⑦ |

Note:

- (*1) V_{DF(T)} : Nominal detect voltage
- (*2) For the N-ch Open Drain, R_{pull}=100kΩ, V_{pull-Up}=V_{IN}
R_{pull}: An External Pull-up resistor
V_{pull-Up}: Pull-up Voltage
- (*3) V_{IN} voltage for V_{OUT} ≤ 0.3V is under detect state.
- (*4) For the detail value, please refer to "Voltage Table" in P10.
- (*5) V_{DF(T)}= 5.5V where V_{IN}=6.0V
- (*6) For V_{DF(T)}> 2.0V products.
- (*7) For V_{DF(T)}> 3.0V products.
- (*8) For V_{DF(T)}> 4.0V products.
- (*9) For V_{DF(T)}> 5.0V products.
- (*10) For the XC6127C (CMOS output)
- (*11) A time between V_{IN}=V_{DFL} and V_{RESETB}=V_{DFL}×0.45 when V_{IN} falls.
- (*12) A time between V_{IN}=V_{DFL}+V_{HYS} and V_{RESETB}=V_{DFL}×0.55 when V_{IN} rises.
- (*13) For the detail value, please refer to "Release Delay Time" in P11.
- (*14) For MRB pin, please do not apply the voltage below V_{SS}.

ELECTRICAL CHARACTERISTICS (Continued)

Ta=25°C

●XC6127CxxF/CxxG/CxxH/CxxJ/CxxK, XC6127NxxF/NxxG/NxxH/NxxJ/NxxK (Output Logic: Active High)

| PARAMETER | | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS | CIRCUIT |
|------------------------------------------|---------------------------|---------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|------------------------|---------------------------|--------|---------|
| Operating Voltage | | V _{IN} | V _{DF(T)} ⁽¹⁾ =1.5~5.5V, MRB=OPEN ⁽²⁾ | 0.7 ⁽³⁾ | | 6.0 | V | - |
| Detect Voltage | | V _{DFH} | V _{DF(T)} =1.5~5.5V, MRB=OPEN | V _{DF(T)} ×0.992 | V _{DF(T)} | V _{DF(T)} ×1.008 | V | ① |
| Hysteresis Width | | V _{HYS} | | V _{DFH} ×0.02 | V _{DFH} ×0.05 | V _{DFH} ×0.08 | V | ① |
| Supply Current 1 | | I _{SS1} | V _{IN} =V _{DFH} ×0.9, MRB=OPEN V _{DF(T)} =1.5~1.8V V _{DF(T)} =1.9~3.0V V _{DF(T)} =3.1~5.5V | - | 0.6 0.7 1.0 | 1.4 1.6 1.9 | μA | ② |
| Supply Current 2 | | I _{SS2} | V _{IN} =V _{DFH} ×1.1 ⁽⁵⁾ , MRB=OPEN V _{DF(T)} =1.5~1.8V V _{DF(T)} =1.9~3.0V V _{DF(T)} =3.1~5.5V | - | 0.7 0.8 1.1 | 1.6 1.9 2.35 | μA | ② |
| RESET Output Current | | I _{ROUT1} | V _{IN} =1.65V ⁽⁶⁾ , V _{RESET} =0.5V(Nch), MRB=OPEN | 0.5 | 1.6 | - | mA | ③ |
| | | | V _{IN} =2.0V ⁽⁷⁾ , V _{RESET} =0.5V(Nch), MRB=OPEN | 4.4 | 7.0 | - | | |
| | | | V _{IN} =3.0V ⁽⁸⁾ , V _{RESET} =0.5V(Nch), MRB=OPEN | 7.0 | 9.0 | - | | |
| | | | V _{IN} =4.0V ⁽⁹⁾ , V _{RESET} =0.5V(Nch), MRB=OPEN | 8.5 | 11.0 | - | | |
| | | | V _{IN} =5.0V ⁽¹⁰⁾ , V _{RESET} =0.5V(Nch), MRB=OPEN | 9.0 | 12.0 | - | | |
| | | | V _{IN} =6.0V, V _{RESET} =0.5V(Nch), MRB=OPEN | 9.0 | 12.0 | - | | |
| | | I _{ROUT2} ⁽¹¹⁾ | V _{IN} =0.7V, V _{RESET} =0.2V(Pch), MRB=OPEN | - | -0.07 | -0.001 | mA | ③ |
| | | | V _{IN} =1.0V, V _{RESET} =0.5V(Pch), MRB=OPEN | - | -0.4 | -0.09 | | |
| | | | V _{IN} =2.0V ⁽¹²⁾ , V _{RESET} =1.5V(Pch), MRB=OPEN | - | -2.0 | -1.3 | | |
| | | | V _{IN} =3.0V ⁽¹³⁾ , V _{RESET} =2.5V(Pch), MRB=OPEN | - | -3.0 | -1.8 | | |
| | | | V _{IN} =4.0V ⁽¹⁴⁾ , V _{RESET} =3.5V(Pch), MRB=OPEN | - | -4.0 | -2.5 | | |
| | | | V _{IN} =5.0V ⁽¹⁵⁾ , V _{RESET} =4.5V(Pch), MRB=OPEN | - | -4.5 | -3.0 | | |
| RESET Leakage Current | CMOS Output (P-ch) | I _{LEAK} | V _{IN} =6.0V, V _{RESET} =0V, MRB=OPEN | - | -0.01 | - | μA | ③ |
| | N-ch Open Drain Output | | V _{IN} =V _{DFH} ×0.9, V _{RESET} =6.0V, MRB=OPEN | - | 0.01 | 0.15 | μA | |
| Temperature Characteristics | | ΔV _{DFH} / (ΔT _{opr} ·V _{DFH}) | -40°C ≤ T _{opr} ≤ 85°C | | ±50 | - | ppm/°C | ① |
| Detect Delay Time ⁽¹⁶⁾ | | t _{DF} | V _{IN} =V _{DFH} ×1.1→V _{DFH} ×0.9 ⁽¹⁶⁾ , MRB=OPEN | - | - | E-3 ⁽¹⁷⁾ | μs | ④ |
| Release Delay Time ⁽¹⁸⁾ | | t _{DR} | V _{IN} =V _{DFH} ×0.9→V _{DFH} ×1.1 ⁽¹⁸⁾ , MRB=OPEN | E-2 ⁽¹⁹⁾ | | | ms | ④ |
| MRB "Low" Level Voltage ⁽²⁰⁾ | | V _{MRL} | V _{DFH} ×1.1 ≤ V _{IN} ≤ 6.0V | V _{SS} | - | 0.3 | V | ⑤ |
| MRB "High" Level Voltage ⁽²⁰⁾ | | V _{MRH} | V _{DFH} ×1.1 ≤ V _{IN} ≤ 6.0V | 1.0 | - | 6.0 | V | ⑤ |
| MRB pull-up Resistance | | R _{MRB} | | 0.4 | 0.8 | 3.0 | MΩ | ⑥ |
| Minimum MRB Pulse Width | | T _{MRB} | V _{IN} =6.0V, Applied pulse to MRB pin, 6.0V→0V | 150 | - | - | ns | ⑦ |

■ ELECTRICAL CHARACTERISTICS (Continued)

- (*1) $V_{DF(T)}$: Nominal detect voltage
- (*2) For the N-ch Open Drain, $R_{pull}=100k\Omega$, $V_{pull-Up}=V_{IN}$
 R_{pull} : An External Pull-up resistor
 $V_{pull-Up}$: Pull-up Voltage
- (*3) V_{IN} voltage for $V_{OUT} \geq 0.4V$ is under detect state.
- (*4) For the detail value, please refer to "Voltage Table" in P10.
- (*5) $V_{DF(T)} = 5.5V$ where $V_{IN}=6.0V$
- (*6) For $V_{DF(T)}=1.5V$ products.
- (*7) For $V_{DF(T)} \leq 1.8V$ products.
- (*8) For $V_{DF(T)} \leq 2.7V$ products.
- (*9) For $V_{DF(T)} \leq 3.6V$ products.
- (*10) For $V_{DF(T)} \leq 4.6V$ products.
- (*11) For the XC6127C (CMOS output)
- (*12) For $V_{DF(T)} > 2.0V$ products.
- (*13) For $V_{DF(T)} > 3.0V$ products.
- (*14) For $V_{DF(T)} > 4.0V$ products.
- (*15) For $V_{DF(T)} > 5.0V$ products.
- (*16) A time between $V_{IN}=V_{DFH}$ and $V_{RESET}=V_{DFH} \times 0.45$ when V_{IN} falls.
- (*17) For the detail value, please refer to "Detect Delay Time" in P11.
- (*18) A time between $V_{IN}=V_{DFH}+V_{HYS}$ and $V_{RESET}=V_{DFH} \times 0.55$ when V_{IN} rises.
- (*19) For the detail value, please refer to "Release Delay Time" in P11.
- (*20) For MRB pin, please do not apply the voltage below V_{SS} .

ELECTRICAL CHARACTERISTICS (Continued)

Voltage Table 1

| NOMINAL DETECT VOLTAGE (V) | DETECT VOLTAGE (V) E-1 | |
|-------------------------------------|--------------------------------------|--------|
| | V _{DFL} or V _{DFH} | |
| V _{DF(T)} | MIN. | MAX. |
| 1.50 | 1.4880 | 1.5120 |
| 1.60 | 1.5872 | 1.6128 |
| 1.70 | 1.6864 | 1.7136 |
| 1.80 | 1.7856 | 1.8144 |
| 1.90 | 1.8848 | 1.9152 |
| 2.00 | 1.9840 | 2.0160 |
| 2.10 | 2.0832 | 2.1168 |
| 2.20 | 2.1824 | 2.2176 |
| 2.30 | 2.2816 | 2.3184 |
| 2.40 | 2.3808 | 2.4192 |
| 2.50 | 2.4800 | 2.5200 |
| 2.60 | 2.5792 | 2.6208 |
| 2.70 | 2.6784 | 2.7216 |
| 2.80 | 2.7776 | 2.8224 |
| 2.90 | 2.8768 | 2.9232 |
| 3.00 | 2.9760 | 3.0240 |
| 3.10 | 3.0752 | 3.1248 |
| 3.20 | 3.1744 | 3.2256 |
| 3.30 | 3.2736 | 3.3264 |
| 3.40 | 3.3728 | 3.4272 |
| 3.50 | 3.4720 | 3.5280 |
| 3.60 | 3.5712 | 3.6288 |
| 3.70 | 3.6704 | 3.7296 |
| 3.80 | 3.7696 | 3.8304 |
| 3.90 | 3.8688 | 3.9312 |
| 4.00 | 3.9680 | 4.0320 |

Voltage Table 2

| NOMINAL DETECT VOLTAGE (V) | DETECT VOLTAGE (V) E-1 | |
|-------------------------------------|--------------------------------------|--------|
| | V _{DFL} or V _{DFH} | |
| V _{DF(T)} | MIN. | MAX. |
| 4.10 | 4.0672 | 4.1328 |
| 4.20 | 4.1664 | 4.2336 |
| 4.30 | 4.2656 | 4.3344 |
| 4.40 | 4.3648 | 4.4352 |
| 4.50 | 4.4640 | 4.5360 |
| 4.60 | 4.5632 | 4.6368 |
| 4.70 | 4.6624 | 4.7376 |
| 4.80 | 4.7616 | 4.8384 |
| 4.90 | 4.8608 | 4.9392 |
| 5.00 | 4.9600 | 5.0400 |
| 5.10 | 5.0592 | 5.1408 |
| 5.20 | 5.1584 | 5.2416 |
| 5.30 | 5.2576 | 5.3424 |
| 5.40 | 5.3568 | 5.4432 |
| 5.50 | 5.4560 | 5.5440 |

■ ELECTRICAL CHARACTERISTICS (Continued)

Release Delay Time Table

| TYPE | RELEASE DELAY TIME (ms) E-2 | | |
|-------------------------|-----------------------------------|------|------|
| | t_{DR} | | |
| | MIN. | TYP. | MAX. |
| | XC6127CxxA / XC6127NxxA | 42.5 | 50 |
| XC6127CxxB / XC6127NxxB | 85 | 100 | 115 |
| XC6127CxxC / XC6127NxxC | 170 | 200 | 230 |
| XC6127CxxD / XC6127NxxD | 340 | 400 | 460 |
| XC6127CxxE / XC6127NxxE | 680 | 800 | 920 |
| XC6127CxxF / XC6127NxxF | 42.5 | 50 | 57.5 |
| XC6127CxxG / XC6127NxxG | 85 | 100 | 115 |
| XC6127CxxH / XC6127NxxH | 170 | 200 | 230 |
| XC6127CxxJ / XC6127NxxJ | 340 | 400 | 460 |
| XC6127CxxK / XC6127NxxK | 680 | 800 | 920 |

Detect Delay Time Table

| TYPE | DETECT DELAY TIME (μ s) E-3 |
|--------------------------------|----------------------------------------|
| | t_{DF} |
| | MAX. |
| | XC6127CxxF/CxxG/CxxH/CxxJ/CxxK |
| XC6127NxxF/NxxG/NxxH/NxxJ/NxxK | 200 |

OPERATIONAL EXPLANATION

1. Detect / Release operation using XC6127CxxA/CxxB/CxxC/CxxD/CxxE, XC6127NxxA/NxxB/NxxC/NxxD/NxxE
(Output Logic: Active Low)

Typical Application Circuit



Timing Chart



A timing chart is used to explain the operation of the typical application circuit when MRB is open.

① In the initial state, an input voltage (V_{IN}) higher than the release voltage (V_{DR}) is applied, and then V_{IN} gradually falls.

While the input voltage (V_{IN}) is higher than the detect voltage (V_{DFL}), an output voltage (V_{RESETB}) equal to the input voltage (V_{IN}) goes out.

*In the case of an N-ch open drain output product, the RESETB pin is in a high-impedance state, and if the output is pulled up, the output voltage (V_{RESETB}) is equal to the pull-up voltage.

②③ After the elapse of the detect delay time (t_{DF}) that starts when the input voltage (V_{IN}) falls below the detect voltage (V_{DFL}), an output voltage (V_{RESETB}) equal to the ground voltage (V_{SS}) goes out (detection state).

*This is the same on the N-ch open drain output product.

④ The input voltage (V_{IN}) drops further, and if it falls below the minimum operating voltage (0.7V), the output becomes undefined state.

*When an N-ch open drain output product is used and the output pin is pulled up, an output voltage (V_{RESETB}) equal to the pull-up voltage may be output.

⑤ The input voltage (V_{IN}) rises past the minimum operating voltage (0.7V), and until it reaches the release voltage (V_{DR}), the output voltage (V_{RESETB}) is equal to the ground voltage.

⑥ From the time that the input voltage (V_{IN}) becomes higher than the release voltage (V_{DR}) until the release delay time (t_{DR}) elapses, the output voltage (V_{RESETB}) remains at the ground voltage due to the delay circuit.

⑦ After the release delay time (t_{DR}) elapses, the output voltage (V_{RESETB}) is equal to the input voltage (V_{IN}) (release state).

*In the case of an N-ch open drain output product, the RESETB pin will be in a high impedance state like ①. If the output is pulled up, an output voltage (V_{RESETB}) equal to the pull-up voltage will be output.

⑧ The difference between the release voltage (V_{DR}) and the detect voltage (V_{DFL}) is the hysteresis width (V_{HYS}).

OPERATIONAL EXPLANATION (Continued)

2. XC6127CxxF/CxxG/CxxH/CxxJ/CxxK, XC6127NxxF/NxxG/NxxH/NxxJ/NxxK (Output Logic: Active High)

Typical Application Circuit



Timing Chart



A timing chart is used above to explain the operation of the typical application circuit when MRB is open.

- ① In the initial state, an input voltage (V_{IN}) higher than the release voltage (V_{DR}) is applied, and then V_{IN} gradually falls.
While the input voltage (V_{IN}) is higher than the detect voltage (V_{DFH}), an output voltage (V_{RESET}) equal to the ground voltage (V_{SS}) goes out.
*This is the same on the N-ch open drain output product.
- ②③ After the elapse of the detect delay time (t_{DF}) that starts when the input voltage (V_{IN}) falls below the detect voltage (V_{DFH}), the output voltage (V_{RESET}) is equal to the input voltage (V_{IN}) (detection state).
*In the case of an N-ch open drain output product, the RESET pin is in a high-impedance state, and if the output is pulled up, the output voltage (V_{RESET}) is equal to the pull-up voltage.
- ④ The input voltage (V_{IN}) drops further, and if it falls below the minimum operating voltage (0.7V), the output becomes undefined state.
- ⑤ The input voltage (V_{IN}) rises past the minimum operating voltage (0.7V), and until it reaches the release voltage (V_{DR}), the output voltage (V_{RESET}) is equal to the V_{IN} voltage.
*In the case of an N-ch open drain output product, the RESET pin is in a high-impedance state, and if the output is pulled up, the output voltage (V_{RESET}) is equal to the pull-up voltage.
- ⑥ From the time that the input voltage (V_{IN}) becomes higher than the release voltage (V_{DR}) until the release delay time (t_{DR}) elapses, the output voltage (V_{RESET}) remains equal to the V_{IN} voltage due to the delay circuit.
- ⑦ After the release delay time (t_{DR}) elapses, the output voltage (V_{RESET}) is equal to the ground voltage (V_{SS}) (release state).
- ⑧ The difference between the release voltage (V_{DR}) and the detect voltage (V_{DFH}) is the hysteresis width (V_{HYS}).

OPERATIONAL EXPLANATION (Continued)

3. MRB Pin

The output pin signal can be forcibly changed to the detect state by an input signal to the MRB pin.

The operation of the circuit at MRB signal input is explained using a timing chart.

When an H level (V_{MRH}) signal and then an L (or less) level (V_{MRL}) signal are input to the MRB input voltage (V_{MRB}) with a voltage equal to or higher than V_{DR} applied to the input voltage (V_{IN}), the output pin outputs release state ^(*) and then detect state ^(**) signals.

During the release delay time (t_{DR}) after the MRB input voltage (V_{MRB}) changes from the L level (V_{MRL}) to the H level (V_{MRH}), the output pin maintains the detection state. After the release delay time (t_{DR}) elapses, the output pin outputs the release state signal.

(*1) The output voltage in the release state is indicated below by product type.

XC6127CxxA/CxxB/CxxC/CxxD/CxxE types, XC6127NxxA/NxxB/NxxC/NxxD/NxxE types (output logic: Active Low)

: Input voltage (V_{IN}) ^(*)

XC6127CxxF/CxxG/CxxH/CxxJ/CxxK types, XC6127NxxF/NxxG/NxxH/NxxJ/NxxK types (output logic: Active High)

: Ground voltage (V_{SS})

(*2) The output voltage in the detect state is indicated below by product type.

XC6127CxxA/CxxB/CxxC/CxxD/CxxE types, XC6127NxxA/NxxB/NxxC/NxxD/NxxE types (output logic: Active Low)

: Ground voltage (V_{SS})

XC6127CxxF/CxxG/CxxH/CxxJ/CxxK types, XC6127NxxF/NxxG/NxxH/NxxJ/NxxK types (output logic: Active High)

: Input voltage (V_{IN}) ^(*)

(*3) On an N-ch open drain output product, if the output is pulled up, the output voltage is the pull-up voltage.

(*4) A pull-up resistance (R_{MRB}) is built-in between the MRB pin and the V_{IN} pin, and thus if a voltage is applied to the MRB pin, current will flow from the V_{IN} pin to the MRB pin.

(*5) The voltage input to the MRB pin should be within the range V_{SS} to 6.0 V.

Timing Chart



NOTE ON USE

1. Please use this IC within the stated maximum ratings. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
2. Note that there is a possibility of malfunctioning if the input voltage changes sharply or undergoes repeated, cyclical changes.
3. If the resistance R_{IN} is connected between the VIN pin and the power supply V_{DD} , the voltage drop due to the flow through current in the internal circuit and R_{IN} may cause oscillation when release takes place. When using the CMOS output product, oscillation due to R_{IN} and the flow through current may occur without relation to release and detection, and thus R_{IN} should not be connected.
4. When N-ch open drain output is used, the output voltage at detection is determined by the pull-up resistance connected to the output pin. Select the resistance based on the following considerations:

Using a XC6127CxxA/CxxB/CxxC/CxxD/CxxE or XC6127NxxA/NxxB/NxxC/NxxD/NxxE (output logic: Active Low)

At detection: $V_{RESETB} = (V_{pull-Up}) / (1 + R_{pull} / R_{ON})$

$V_{pull-Up}$: Voltage after pull-up

$R_{ON}^{(*)1}$: ON resistance of N-ch driver (calculated from V_{RESETB} / I_{RBOU1} in electrical characteristics) ^{(*)3}

Example calculation:

When $V_{IN} = 2.0V^{(*)2}$, $R_{ON} = 0.5 / 4.4 \times 10^{-3} \approx 114 \Omega$ (MAX.). If you wish to make the V_{RESETB} voltage at detection 0.1V or lower with $V_{pull-Up} = 3.0V$,

$$R_{pull} = (V_{pull-Up} / V_{RESETB} - 1) \times R_{ON} = (3 / 0.1 - 1) \times 114 \approx 3.3k\Omega, \text{ and thus}$$

to make the output voltage at detection 0.1V or less under the above conditions, the pull-up resistance must be 3.3k Ω or higher.

(*)1 The smaller V_{IN} is, the larger R_{ON} becomes.

(*)2 When selecting V_{IN} , calculate using the lowest value of the input voltage range you will use.

(*)3 I_{RBOU1} specified in the electrical characteristics is the value at $T_a = 25^\circ C$. I_{RBOU1} varies depending on the ambient temperature.

To select the pull-up resistance taking ambient temperature into account, please consult us.

At release: $V_{RESETB} = (V_{pull-Up}) / (1 + R_{pull} / R_{OFF})$

$V_{pull-Up}$: Voltage after pull-up

R_{OFF} : Resistance value 40M Ω (MIN.) when N-ch driver is OFF (calculated from V_{RESETB} / I_{LEAK} in electrical characteristics)

Calculation example:

If you wish to make V_{RESETB} 5.99V or higher with $V_{pull-Up} = 6.0V$

$$R_{pull} = (V_{pull-Up} / V_{RESETB} - 1) \times R_{OFF} = (6 / 5.99 - 1) \times 40 \times 10^6 \approx 66k\Omega, \text{ and thus}$$

to make the output voltage 5.99V or higher at release under the above conditions, the pull-up resistance must be 66k Ω or less.

Using the XC6127CxxF/CxxG/CxxH/CxxJ/CxxK, or XC6127NxxF/NxxG/NxxH/NxxJ/NxxK (output logic: Active High)

At detection : $V_{RESET} = (V_{pull-Up}) / (1 + R_{pull} / R_{OFF})$

$V_{pull-Up}$: Voltage after pull-up

R_{OFF} : When the N-ch driver is OFF, the resistance is 40M Ω (MIN.) (calculated from V_{RESET} / I_{LEAK} in the electrical characteristics)

Calculation example:

If you wish to make V_{RESET} 5.99V or higher with $V_{pull-Up} = 6.0V$

$$R_{pull} = (V_{pull-Up} / V_{RESET} - 1) \times R_{OFF} = (6 / 5.99 - 1) \times 40 \times 10^6 \approx 66k\Omega \text{ and thus}$$

to make the output voltage 5.99V or higher at detection under the above conditions, the pull-up resistance must be 66k Ω or less.

At release : $V_{RESET} = (V_{pull-Up}) / (1 + R_{pull} / R_{ON})$

$V_{pull-Up}$: Voltage after pull-up

$R_{ON}^{(*)1}$: ON resistance of N-ch driver (calculated from V_{RESET} / I_{ROUT1} in the electrical characteristics) ^{(*)3}

Calculation example:

When $V_{IN} = 2.0V^{(*)2}$, $R_{ON} = 0.5 / 4.4 \times 10^{-3} \approx 114 \Omega$ (MAX.). If you wish to make the V_{RESET} voltage 0.1V or lower at detection with $V_{pull-Up} = 3.0V$,

$$R_{pull} = (V_{pull-Up} / V_{RESET} - 1) \times R_{ON} = (3 / 0.1 - 1) \times 114 \approx 3.3k\Omega \text{ and thus}$$

to make the output voltage 0.1V or lower at release under the above conditions, the pull-up resistance must be 3.3k Ω or higher.

(*)1 The smaller V_{IN} is the larger R_{ON} becomes.

(*)2 When selecting V_{IN} , calculate using the lowest value of the input voltage range you will be using.

(*)3 I_{ROUT1} specified in the electrical characteristics is the value at $T_a = 25^\circ C$. I_{ROUT1} varies depending on the ambient temperature.

To select the pull-up resistance taking ambient temperature into account, please consult us.

5. We work hard to improve our products and increase reliability. Nevertheless, to allow for the unexpected, please employ a design such as a failsafe design that is sufficiently safe in terms of both devices and the system, and conduct aging or other testing.

TEST CIRCUITS

Circuit 1



Circuit 2



Circuit 3



Circuit 4



■ TEST CIRCUITS (Continued)

Circuit 5



Circuit 6



Circuit 7



PACKAGING INFORMATION

Unit:mm

●USPN-4



●USPN-4 Reference Pattern Layout



●USPN-4 Reference Metal Mask Design



■ PACKAGING INFORMATION (Continued)

Unit:mm

● SSOT-24



● SOT-25



MARKING RULE

●USPN-4



① represents product series and output configuration.

| MARK | OUTPUT CONFIGURATION | PRODUCT SERIES |
|------|----------------------|----------------|
| F | CMOS | XC6127C****-G |
| H | Nch | XC6127N****-G |

② represents detect voltage.

| MARK | OUTPUT VOLTAGE(V) | | MARK | OUTPUT VOLTAGE(V) | | MARK | OUTPUT VOLTAGE(V) | |
|------|-------------------|-----|------|-------------------|-----|------|-------------------|-----|
| A | 1.5 | 1.6 | K | 2.9 | 3.0 | T | 4.3 | 4.4 |
| B | 1.7 | 1.8 | L | 3.1 | 3.2 | U | 4.5 | 4.6 |
| C | 1.9 | 2.0 | M | 3.3 | 3.4 | V | 4.7 | 4.8 |
| D | 2.1 | 2.2 | N | 3.5 | 3.6 | X | 4.9 | 5.0 |
| E | 2.3 | 2.4 | P | 3.7 | 3.8 | Y | 5.1 | 5.2 |
| F | 2.5 | 2.6 | R | 3.9 | 4.0 | Z | 5.3 | 5.4 |
| H | 2.7 | 2.8 | S | 4.1 | 4.2 | 0 | 5.5 | - |

③ represents detect voltage range and release delay time / detect logic.

| MARK | DETECT VOLTAGE [V] | RELEASE DELAY TIME/ DETECT LOGIC | PRODUCT SERIES | |
|------|--------------------|----------------------------------|---------------------------------|---------------------------------|
| A | Odd number | 50ms/Low | XC6127*15A**-G ~ XC6127*55A**-G | |
| B | | 100ms/Low | XC6127*15B**-G ~ XC6127*55B**-G | |
| C | | 200ms/Low | XC6127*15C**-G ~ XC6127*55C**-G | |
| D | | 400ms/Low | XC6127*15D**-G ~ XC6127*55D**-G | |
| E | | 800ms/Low | XC6127*15E**-G ~ XC6127*55E**-G | |
| F | | 50ms/High | XC6127*15F**-G ~ XC6127*55F**-G | |
| H | | 100ms/High | XC6127*15G**-G ~ XC6127*55G**-G | |
| K | | 200ms/High | XC6127*15H**-G ~ XC6127*55H**-G | |
| L | | 400ms/High | XC6127*15J**-G ~ XC6127*55J**-G | |
| M | | 800ms/High | XC6127*15K**-G ~ XC6127*55K**-G | |
| N | | Even number | 50ms/Low | XC6127*16A**-G ~ XC6127*54A**-G |
| P | | | 100ms/Low | XC6127*16B**-G ~ XC6127*54B**-G |
| R | | | 200ms/Low | XC6127*16C**-G ~ XC6127*54C**-G |
| S | | | 400ms/Low | XC6127*16D**-G ~ XC6127*54D**-G |
| T | 800ms/Low | | XC6127*16E**-G ~ XC6127*54E**-G | |
| U | 50ms/High | | XC6127*16F**-G ~ XC6127*54F**-G | |
| V | 100ms/High | | XC6127*16G**-G ~ XC6127*54G**-G | |
| X | 200ms/High | | XC6127*16H**-G ~ XC6127*54H**-G | |
| Y | 400ms/High | | XC6127*16J**-G ~ XC6127*54J**-G | |
| Z | 800ms/High | | XC6127*16K**-G ~ XC6127*54K**-G | |

④ represents production lot number

0 to 9, A to Z, and inverted 0 to 9, A to Z repeated. (G, I, J, O, Q, W excepted.)

* No character inversion used.

■ MARKING RULE (Continued)

● SSOT-24

SSOT-24

(With the orientation bar at the top)



SSOT-24

(With the orientation bar at the bottom)



①-1 represents product series and detect voltage range, output configuration.

| MARK | OUTPUT CONFIGURATION | DETECT VOLTAGE [V] | RELEASE DELAY TIME/ DETECT LOGIC | PRODUCT SERIES |
|------|----------------------|--------------------|-------------------------------------|---------------------------------|
| 5 | CMOS | Odd number | 50ms/Low | XC6127C15A**-G ~ XC6127C55A**-G |
| 6 | | | 100ms/Low | XC6127C15B**-G ~ XC6127C55B**-G |
| 7 | | | 200ms/Low | XC6127C15C**-G ~ XC6127C55C**-G |
| 8 | | | 400ms/Low | XC6127C15D**-G ~ XC6127C55D**-G |
| 9 | | | 800ms/Low | XC6127C15E**-G ~ XC6127C55E**-G |
| A | | | 50ms/High | XC6127C15F**-G ~ XC6127C55F**-G |
| B | | | 100ms/High | XC6127C15G**-G ~ XC6127C55G**-G |
| C | | | 200ms/High | XC6127C15H**-G ~ XC6127C55H**-G |
| D | | | 400ms/High | XC6127C15J**-G ~ XC6127C55J**-G |
| E | | | 800ms/High | XC6127C15K**-G ~ XC6127C55K**-G |
| F | | Even number | 50ms/Low | XC6127C16A**-G ~ XC6127C54A**-G |
| H | | | 100ms/Low | XC6127C16B**-G ~ XC6127C54B**-G |
| K | | | 200ms/Low | XC6127C16C**-G ~ XC6127C54C**-G |
| N | | | 400ms/Low | XC6127C16D**-G ~ XC6127C54D**-G |
| P | | | 800ms/Low | XC6127C16E**-G ~ XC6127C54E**-G |
| R | | | 50ms/High | XC6127C16F**-G ~ XC6127C54F**-G |
| S | | | 100ms/High | XC6127C16G**-G ~ XC6127C54G**-G |
| T | | | 200ms/High | XC6127C16H**-G ~ XC6127C54H**-G |
| U | | | 400ms/High | XC6127C16J**-G ~ XC6127C54J**-G |
| V | | | 800ms/High | XC6127C16K**-G ~ XC6127C54K**-G |

* The products of CMOS output configuration are shipped in the package having the orientation bar marked in the top.

MARKING RULE (Continued)

①-2 represents product series and detect voltage range, output configuration.

| MARK | OUTPUT CONFIGURATION | DETECT VOLTAGE [V] | RELEASE DELAY TIME/ DETECT LOGIC | PRODUCT SERIES |
|------|----------------------|--------------------|----------------------------------|---------------------------------|
| 0 | Nch | Odd number | 50ms/Low | XC6127N15A**-G ~ XC6127N55A**-G |
| 1 | | | 100ms/Low | XC6127N15B**-G ~ XC6127N55B**-G |
| 2 | | | 200ms/Low | XC6127N15C**-G ~ XC6127N55C**-G |
| 3 | | | 400ms/Low | XC6127N15D**-G ~ XC6127N55D**-G |
| 4 | | | 800ms/Low | XC6127N15E**-G ~ XC6127N55E**-G |
| 5 | | | 50ms/High | XC6127N15F**-G ~ XC6127N55F**-G |
| 6 | | | 100ms/High | XC6127N15G**-G ~ XC6127N55G**-G |
| 7 | | | 200ms/High | XC6127N15H**-G ~ XC6127N55H**-G |
| 8 | | | 400ms/High | XC6127N15J**-G ~ XC6127N55J**-G |
| 9 | | | 800ms/High | XC6127N15K**-G ~ XC6127N55K**-G |
| A | | Even number | 50ms/Low | XC6127N16A**-G ~ XC6127N54A**-G |
| B | | | 100ms/Low | XC6127N16B**-G ~ XC6127N54B**-G |
| C | | | 200ms/Low | XC6127N16C**-G ~ XC6127N54C**-G |
| D | | | 400ms/Low | XC6127N16D**-G ~ XC6127N54D**-G |
| E | | | 800ms/Low | XC6127N16E**-G ~ XC6127N54E**-G |
| F | | | 50ms/High | XC6127N16F**-G ~ XC6127N54F**-G |
| H | | | 100ms/High | XC6127N16G**-G ~ XC6127N54G**-G |
| K | | | 200ms/High | XC6127N16H**-G ~ XC6127N54H**-G |
| L | | | 400ms/High | XC6127N16J**-G ~ XC6127N54J**-G |
| M | | | 800ms/High | XC6127N16K**-G ~ XC6127N54K**-G |

* The products of Nch output configuration are shipped in the package having the orientation bar marked in the bottom.

② represents detect voltage.

| MARK | OUTPUT VOLTAGE(V) | | MARK | OUTPUT VOLTAGE(V) | | MARK | OUTPUT VOLTAGE(V) | |
|------|-------------------|-----|------|-------------------|-----|------|-------------------|-----|
| A | 1.5 | 1.6 | K | 2.9 | 3.0 | T | 4.3 | 4.4 |
| B | 1.7 | 1.8 | L | 3.1 | 3.2 | U | 4.5 | 4.6 |
| C | 1.9 | 2.0 | M | 3.3 | 3.4 | V | 4.7 | 4.8 |
| D | 2.1 | 2.2 | N | 3.5 | 3.6 | X | 4.9 | 5.0 |
| E | 2.3 | 2.4 | P | 3.7 | 3.8 | Y | 5.1 | 5.2 |
| F | 2.5 | 2.6 | R | 3.9 | 4.0 | Z | 5.3 | 5.4 |
| H | 2.7 | 2.8 | S | 4.1 | 4.2 | 0 | 5.5 | - |

③④ represents production lot number. 01~09, 0A~0Z, 11~9Z, A1~A9, AA~AZ, B1~ZZ repeated.

(G, I, J, O, Q, W excluded.)

* No character inversion used.

MARKING RULE (Continued)

● SOT-25



① represents product series and output configuration.

| MARK | OUTPUT CONFIGURATION | PRODUCT SERIES |
|------|----------------------|----------------|
| 5 | CMOS | XC6127C****-G |
| 6 | Nch | XC6127N****-G |

* SOT-25 with the under-dot marking is used.

② represents detect voltage.

| MARK | OUTPUT VOLTAGE(V) | | MARK | OUTPUT VOLTAGE(V) | | MARK | OUTPUT VOLTAGE(V) | |
|------|-------------------|-----|------|-------------------|-----|------|-------------------|-----|
| A | 1.5 | 1.6 | K | 2.9 | 3.0 | T | 4.3 | 4.4 |
| B | 1.7 | 1.8 | L | 3.1 | 3.2 | U | 4.5 | 4.6 |
| C | 1.9 | 2.0 | M | 3.3 | 3.4 | V | 4.7 | 4.8 |
| D | 2.1 | 2.2 | N | 3.5 | 3.6 | X | 4.9 | 5.0 |
| E | 2.3 | 2.4 | P | 3.7 | 3.8 | Y | 5.1 | 5.2 |
| F | 2.5 | 2.6 | R | 3.9 | 4.0 | Z | 5.3 | 5.4 |
| H | 2.7 | 2.8 | S | 4.1 | 4.2 | 0 | 5.5 | - |

③ represents detect voltage range and release delay time / detect logic.

| MARK | DETECT VOLTAGE [V] | RELEASE DELAY TIME/ DETECT LOGIC | PRODUCT SERIES | |
|------|--------------------|----------------------------------|---------------------------------|---------------------------------|
| A | Odd number | 50ms/Low | XC6127*15A**-G ~ XC6127*55A**-G | |
| B | | 100ms/Low | XC6127*15B**-G ~ XC6127*55B**-G | |
| C | | 200ms/Low | XC6127*15C**-G ~ XC6127*55C**-G | |
| D | | 400ms/Low | XC6127*15D**-G ~ XC6127*55D**-G | |
| E | | 800ms/Low | XC6127*15E**-G ~ XC6127*55E**-G | |
| F | | 50ms/High | XC6127*15F**-G ~ XC6127*55F**-G | |
| H | | 100ms/High | XC6127*15G**-G ~ XC6127*55G**-G | |
| K | | 200ms/High | XC6127*15H**-G ~ XC6127*55H**-G | |
| L | | 400ms/High | XC6127*15J**-G ~ XC6127*55J**-G | |
| M | | 800ms/High | XC6127*15K**-G ~ XC6127*55K**-G | |
| N | | Even number | 50ms/Low | XC6127*16A**-G ~ XC6127*54A**-G |
| P | | | 100ms/Low | XC6127*16B**-G ~ XC6127*54B**-G |
| R | 200ms/Low | | XC6127*16C**-G ~ XC6127*54C**-G | |
| S | 400ms/Low | | XC6127*16D**-G ~ XC6127*54D**-G | |
| T | 800ms/Low | | XC6127*16E**-G ~ XC6127*54E**-G | |
| U | 50ms/High | | XC6127*16F**-G ~ XC6127*54F**-G | |
| V | 100ms/High | | XC6127*16G**-G ~ XC6127*54G**-G | |
| X | 200ms/High | | XC6127*16H**-G ~ XC6127*54H**-G | |
| Y | 400ms/High | | XC6127*16J**-G ~ XC6127*54J**-G | |
| Z | 800ms/High | | XC6127*16K**-G ~ XC6127*54K**-G | |

③④ represents production lot number. 01~09, 0A~0Z, 11~9Z, A1~A9, AA~AZ, B1~ZZ repeated.

(G, I, J, O, Q, W excluded.)

* No character inversion used.

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- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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